

# Wiring, Printed - Component

**COMPANY**

**Shenzhen Xindaxing Electronic Technology Co., Ltd.**

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E535137

Type	Cond Width		Min Cond Thk	SS/ DS/ DSO	Area Diam	Max Report date After	Surface Mount	Assembly Solder Process	Solder Process	Max Solder Limits	Oper Temp	Meets UL796	C Flame	I DSR
	mm	mm												
<b>Multilayer printed wiring boards</b>														
<b>XDX-M</b>	0.1	0.1	17 Int:68	DS	50.8	No	-	-	-	288	20	130	V-0	All 3
<b>Single layer printed wiring boards</b>														
<b>XDX-D</b>	0.1	0.1	17	DS	50.8	No	-	-	-	288	20	130	V-0	All 3

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

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